74LVC1G14-Q100

Single Schmitt trigger inverter

Rev. 9 — 15 November 2024 | Product data sheet

1. General description

The 74LVC1G14-Q100 is a single inverter with Schmitt-trigger inputs. Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environments. This device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 1.65 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- I_{OFF} circuitry provides partial Power-down mode operation
- ±24 mA output drive (V_{CC} = 3.0 V)
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Unlimited rise and fall times
- Complies with JEDEC standard:
  - JESD8-7 (1.65 V to 1.95 V)
  - JESD8-5 (2.3 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
  - JESD36 (4.5 V to 5.5 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options

3. Applications

- Wave and pulse shaper
- Astable multivibrator
- Monostable multivibrator

4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G14GW-Q100	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74LVC1G14GV-Q100	-40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74LVC1G14GM-Q100	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74LVC1G14GX4-Q100	-40 °C to +125 °C	X2SON4	plastic thermal enhanced extremely thin small outline package; no leads; 4 terminals; body 0.6 × 0.6 × 0.32 mm	SOT1269-2
74LVC1G14GZ-Q100	-40 °C to +125 °C	XSON5	plastic thermal enhanced extremely thin small outline package with side-wettable flanks (SWF); no leads; 5 terminals; body 1.1 × 0.85 × 0.5 mm	SOT8065-1

5. Marking

Table 2. Marking

Type number	Marking code[1]
74LVC1G14GW-Q100	VF
74LVC1G14GV-Q100	V14
74LVC1G14GM-Q100	VF
74LVC1G14GX4-Q100	VF
74LVC1G14GZ-Q100	VF

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram

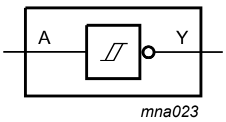


Fig. 1. Logic symbol

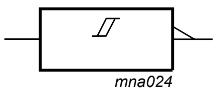


Fig. 2. IEC logic symbol

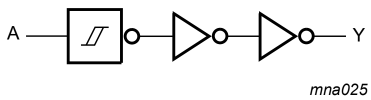
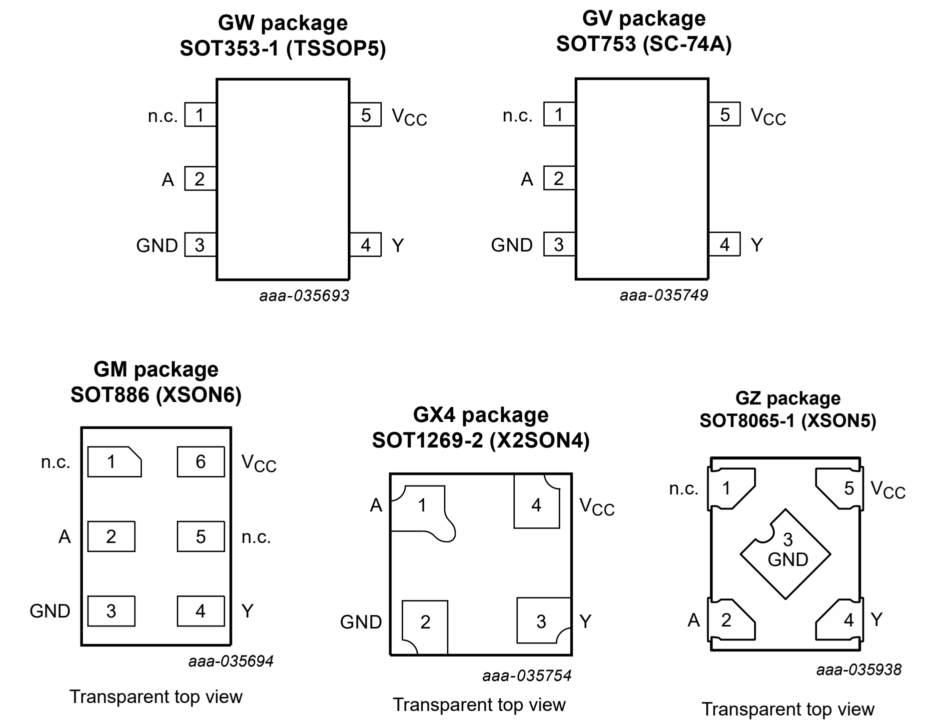


Fig. 3. Logic diagram

7. Pinning information

7.1. Pinning



7.2. Pin description

Table 3. Pin description

Symbol	Pin			Description
	TSSOP5, SC-74A and XSON5	XSON6	X2SON4	
n.c.	1	1, 5	-	not connected
A	2	2	1	data input
GND	3	3	2	ground (0 V)
Y	4	4	3	data output
V_{CC}	5	6	4	supply voltage

8. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

Input	Output
A	**Y**
L	H
H	L

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+6.5	V
V_I	input voltage		[1]	-0.5	+6.5	V
V_O	output voltage	Active mode	[1]	-0.5	V_{CC} + 0.5	V
		Power-down mode; V_{CC} = 0 V	[1]	-0.5	+6.5	V
I_{IK}	input clamping current	V_I < 0 V		-50	-	mA
I_{OK}	output clamping current	V_O > V_{CC} or V_O < 0 V		-	±50	mA
I_O	output current	V_O = 0 V to V_{CC}		-	±50	mA
I_{CC}	supply current			-	+100	mA
I_{GND}	ground current			-100	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C				
		SOT353-1 (TSSOP5) SOT753 (SC-74A) SOT886 (XSON6) SOT8065-1 (XSON5)	[2]	-	250	mW
		SOT1269-2 (X2SON4)	[3]	-	150	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.
For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT8065-1 (XSON5) package: P_{tot} derates linearly with 3.2 mW/K above 72 °C.

[3] For SOT1269-2 (X2SON4) package: P_{tot} derates linearly with 1.7 mW/K above 57 °C.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage		1.65	-	5.5	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage	Active mode	0	-	V_{CC}	V
		Power-down mode; V_{CC} = 0 V	0	-	5.5	V
T_{amb}	ambient temperature		-40	-	+125	°C

11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V_{OH}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}						
		I_O = -100 μA; V_{CC} = 1.65 V to 5.5 V	V_{CC} - 0.1	-	-	V_{CC} - 0.1	-	V
		I_O = -4 mA; V_{CC} = 1.65 V	1.2	1.54	-	0.95	-	V
		I_O = -8 mA; V_{CC} = 2.3 V	1.9	2.15	-	1.7	-	V
		I_O = -12 mA; V_{CC} = 2.7 V	2.2	2.50	-	1.9	-	V
		I_O = -24 mA; V_{CC} = 3.0 V	2.3	2.62	-	2.0	-	V
		I_O = -32 mA; V_{CC} = 4.5 V	3.8	4.11	-	3.4	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}						
		I_O = 100 μA; V_{CC} = 1.65 V to 5.5 V	-	-	0.10	-	0.10	V
		I_O = 4 mA; V_{CC} = 1.65 V	-	0.07	0.45	-	0.70	V
		I_O = 8 mA; V_{CC} = 2.3 V	-	0.12	0.30	-	0.45	V
		I_O = 12 mA; V_{CC} = 2.7 V	-	0.17	0.40	-	0.60	V
		I_O = 24 mA; V_{CC} = 3.0 V	-	0.33	0.55	-	0.80	V
		I_O = 32 mA; V_{CC} = 4.5 V	-	0.39	0.55	-	0.80	V
I_I	input leakage current	V_I = 5.5 V or GND; V_{CC} = 0 V to 5.5 V	-	±0.1	±1	-	±1	μA
I_{OFF}	power-off leakage current	V_I or V_O = 5.5 V; V_{CC} = 0 V	-	±0.1	±2	-	±2	μA
I_{CC}	supply current	V_I = 5.5 V or GND; I_O = 0 A; V_{CC} = 1.65 V to 5.5 V	-	0.1	4	-	4	μA
ΔI_{CC}	additional supply current	$V_I = V_{CC}$ - 0.6 V; I_O = 0 A; V_{CC} = 2.3 V to 5.5 V	-	5	500	-	500	μA
C_I	input capacitance	V_{CC} = 3.3 V; V_I = GND to V_{CC}	-	5.0	-	-	-	pF

[1] All typical values are measured at maximum V_{CC} and T_{amb} = 25 °C.

11.1. Transfer characteristics

Table 8. Transfer characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
V_{T+}	positive-going threshold voltage	see Fig. 4 and Fig. 5						
		V_{CC} = 1.8 V	0.82	1.0	1.14	0.79	1.14	V
		V_{CC} = 2.3 V	1.03	1.2	1.40	1.00	1.40	V
		V_{CC} = 3.0 V	1.29	1.5	1.71	1.26	1.71	V
		V_{CC} = 4.5 V	1.84	2.1	2.36	1.81	2.36	V
		V_{CC} = 5.5 V	2.19	2.5	2.79	2.16	2.79	V
V_{T-}	negative-going threshold voltage	see Fig. 4 and Fig. 5						
		V_{CC} = 1.8 V	0.46	0.6	0.75	0.46	0.78	V
		V_{CC} = 2.3 V	0.65	0.8	0.96	0.65	0.99	V
		V_{CC} = 3.0 V	0.88	1.0	1.24	0.88	1.27	V
		V_{CC} = 4.5 V	1.32	1.5	1.84	1.32	1.87	V
		V_{CC} = 5.5 V	1.58	1.8	2.24	1.58	2.27	V
V_H	hysteresis voltage	(V_{T+} - V_{T-}); see Fig. 4, Fig. 5 and Fig. 6						
		V_{CC} = 1.8 V	0.26	0.4	0.51	0.19	0.51	V
		V_{CC} = 2.3 V	0.28	0.4	0.57	0.22	0.57	V
		V_{CC} = 3.0 V	0.31	0.5	0.64	0.25	0.64	V
		V_{CC} = 4.5 V	0.40	0.6	0.77	0.34	0.77	V
		V_{CC} = 5.5 V	0.47	0.6	0.88	0.41	0.88	V

[1] Typical values are measured at T_{amb} = 25 °C.

11.2. Waveforms transfer characteristics

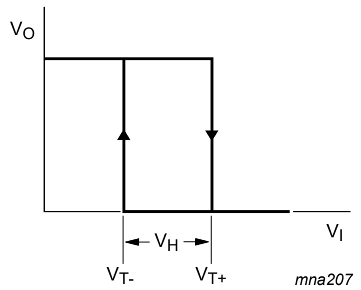
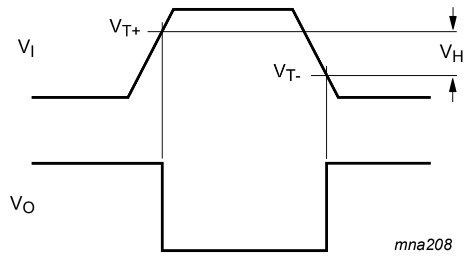
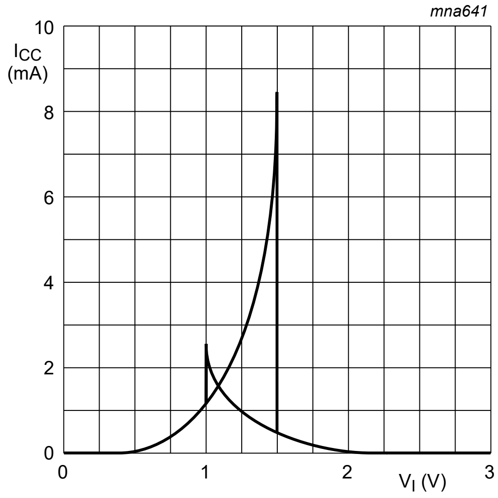


Fig. 4. Transfer characteristic



V_{T+} and V_{T-} limits at 70 % and 20 %.

Fig. 5. Definition of V_{T+}, V_{T-} and V_H



V_{CC} = 3.0 V.

Fig. 6. Typical transfer characteristics

12. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	
t_{pd}	propagation delay	A to Y; see Fig. 7 [2]						
		V_{CC} = 1.65 V to 1.95 V	1.0	4.1	11.0	1.0	14.0	ns
		V_{CC} = 2.3 V to 2.7 V	0.7	2.8	6.5	0.7	8.5	ns
		V_{CC} = 2.7 V	0.7	3.2	6.5	0.7	8.5	ns
		V_{CC} = 3.0 V to 3.6 V	0.7	3.0	5.5	0.7	7.0	ns
		V_{CC} = 4.5 V to 5.5 V	0.7	2.2	5.0	0.7	6.5	ns
C_{PD}	power dissipation capacitance	V_{CC} = 3.3 V; V_I = GND to V_{CC} [3]	-	15.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i + (C_L \times V_{CC}^2 \times f_o)$ where:

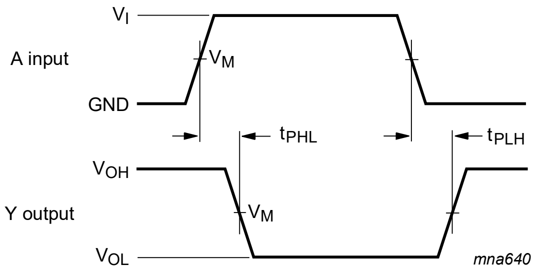
f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V.

12.1. Waveform and test circuit



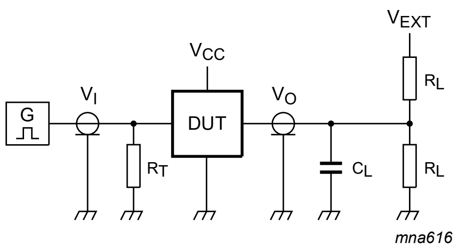
Measurement points are given in Table 10.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 7. The data input (A) to output (Y) propagation delays

Table 10. Measurement points

Supply voltage	Input	Output
V_{CC}	V_M	V_M
1.65 V to 1.95 V	0.5 × V_{CC}	0.5 × V_{CC}
2.3 V to 2.7 V	0.5 × V_{CC}	0.5 × V_{CC}
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	0.5 × V_{CC}	0.5 × V_{CC}



Test data is given in Table 11.

Definitions for test circuit:

R_L = Load resistance;

C_L = Load capacitance including jig and probe capacitance;

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator;

V_{EXT} = External voltage for measuring switching times.

Fig. 8. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load		V_{EXT}
V_{CC}	V_I	$t_r = t_f$	C_L	R_L	t_{PLH}, t_{PHL}
1.65 V to 1.95 V	V_{CC}	≤ 2.0 ns	30 pF	1 kΩ	open
2.3 V to 2.7 V	V_{CC}	≤ 2.0 ns	30 pF	500 Ω	open
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open
4.5 V to 5.5 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	open

13. Application information

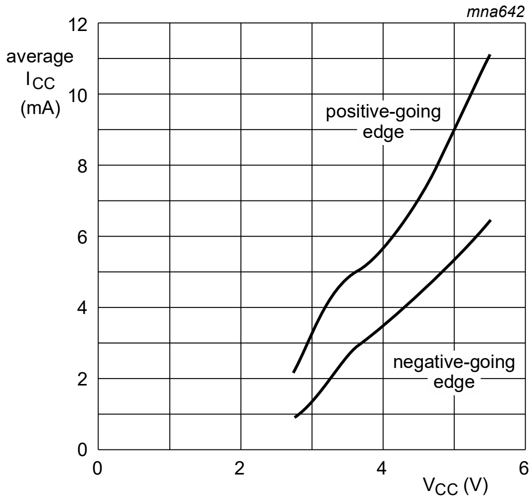
The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$ where:

- P_{add} = additional power dissipation (μW);
- f_i = input frequency (MHz);
- t_r = input rise time (ns); 10 % to 90 %;
- t_f = input fall time (ns); 90 % to 10 %;
- $\Delta I_{CC(AV)}$ = average additional supply current (μA).

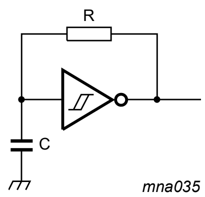
Average $\Delta I_{CC(AV)}$ differs with positive or negative input transitions, as shown in Fig. 9.

An example of a relaxation circuit using the 74LVC1G14-Q100 is shown in Fig. 10.



Linear change of V_I between 0.8 V to 2.0 V.
All values given are typical unless otherwise specified.

Fig. 9. Average additional supply current as a function of supply voltage



$$f = \frac{1}{T} \approx \frac{1}{K \times RC}$$

For K-factor, see Fig. 11.

Fig. 10. Relaxation oscillator

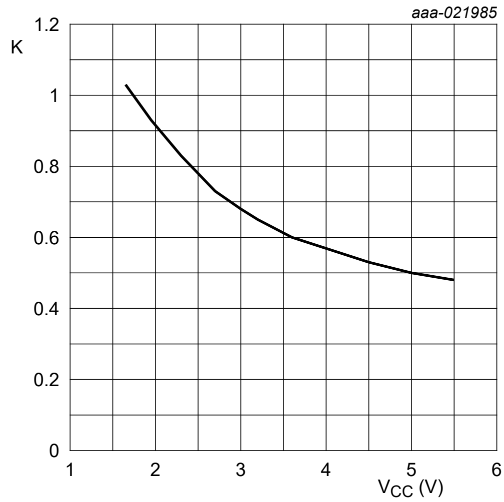
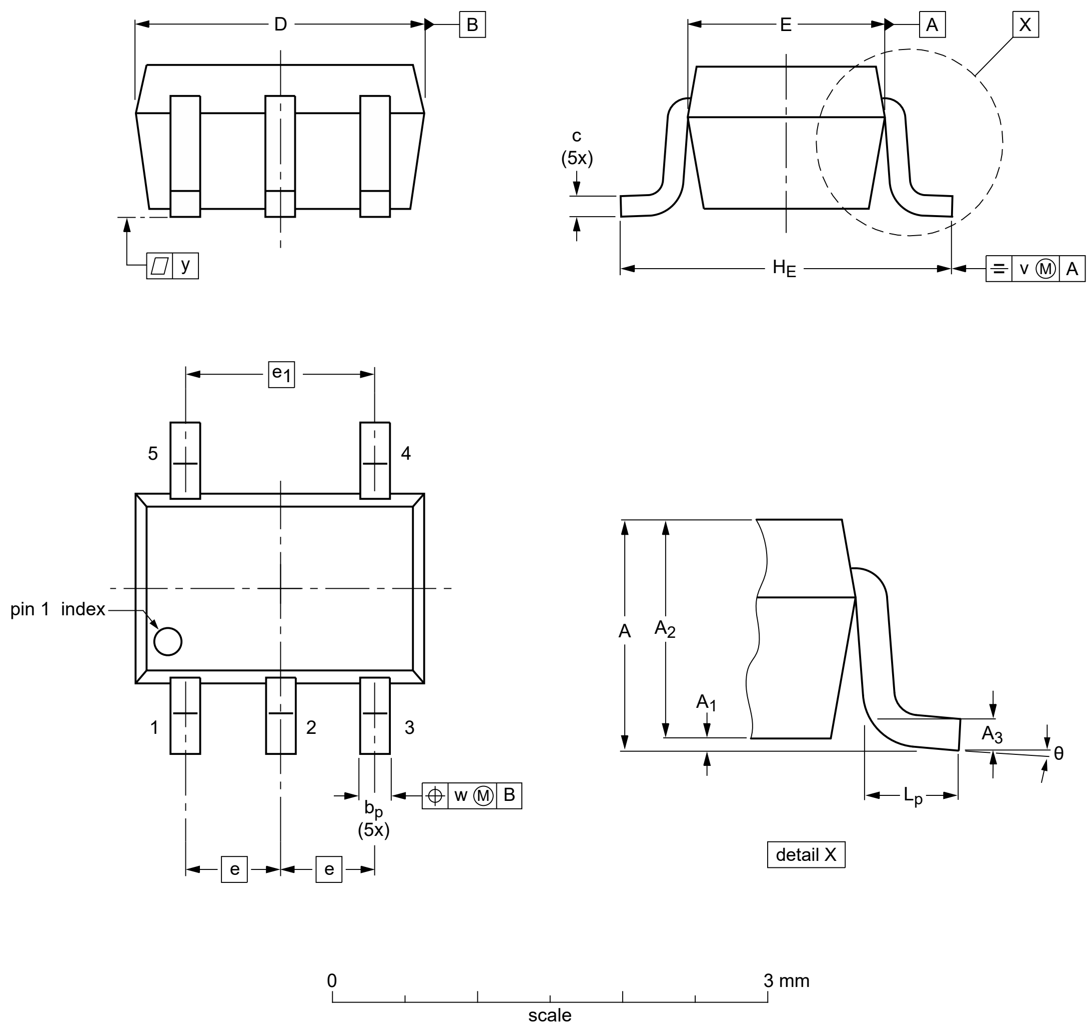


Fig. 11. Typical K-factor for relaxation oscillator

14. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm **SOT353-1**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	D(1)	E(1)	e	e_1	H_E	L_p	v	w	y	θ
mm	max	1.1	0.1	1.0	0.15	0.30	0.25	2.2	1.35	0.65	1.3	2.4	0.46	0.3	0.1	0.1	8°
	min	0.8	0	0.8		0.15	0.08	1.8	1.15			1.8	0.26				0°

Note

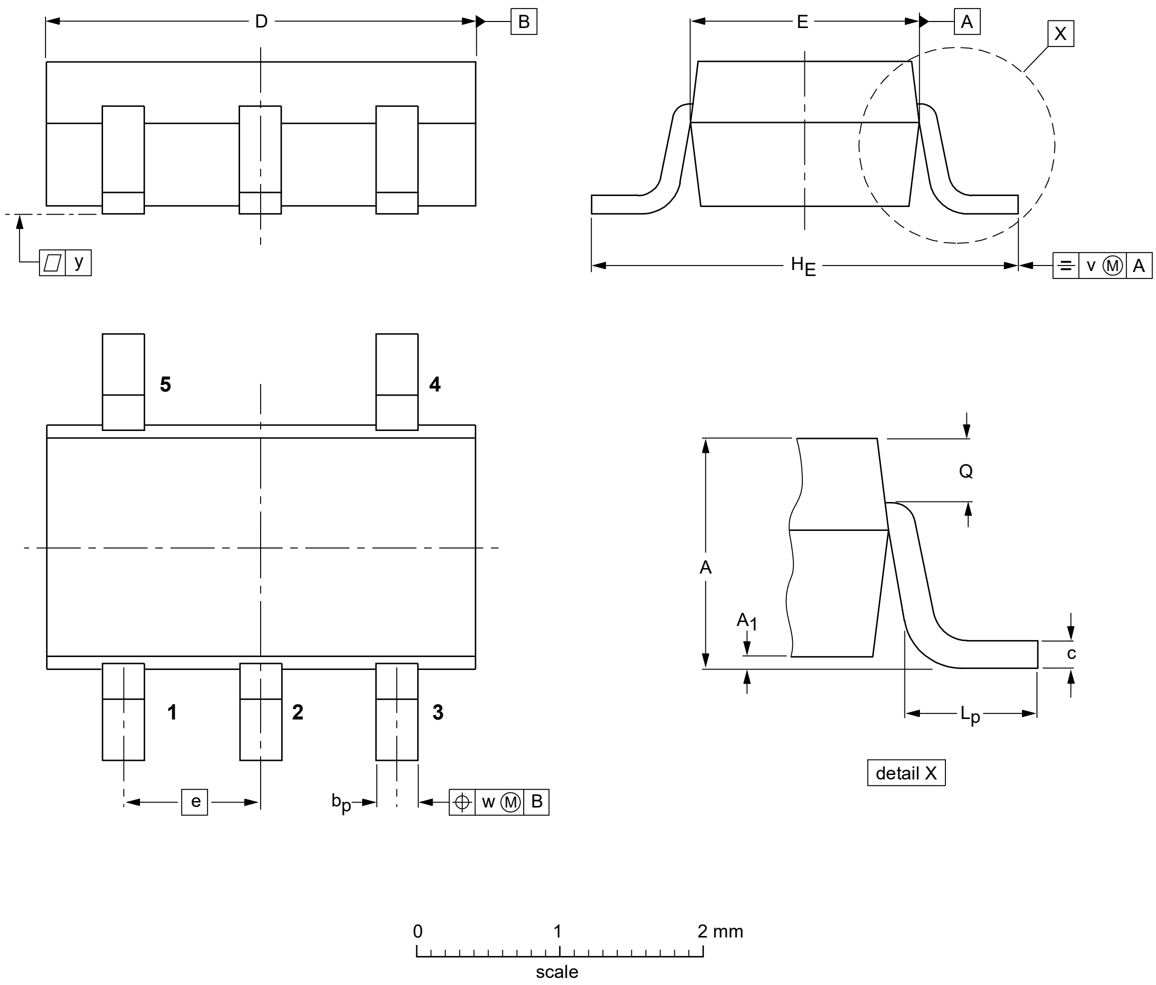
1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

sot353-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT353-1		MO-203	SC-88A			~~21-12-15~~ 21-12-16

Fig. 12. Package outline SOT353-1 (TSSOP5)

Plastic surface-mounted package; 5 leads **SOT753**



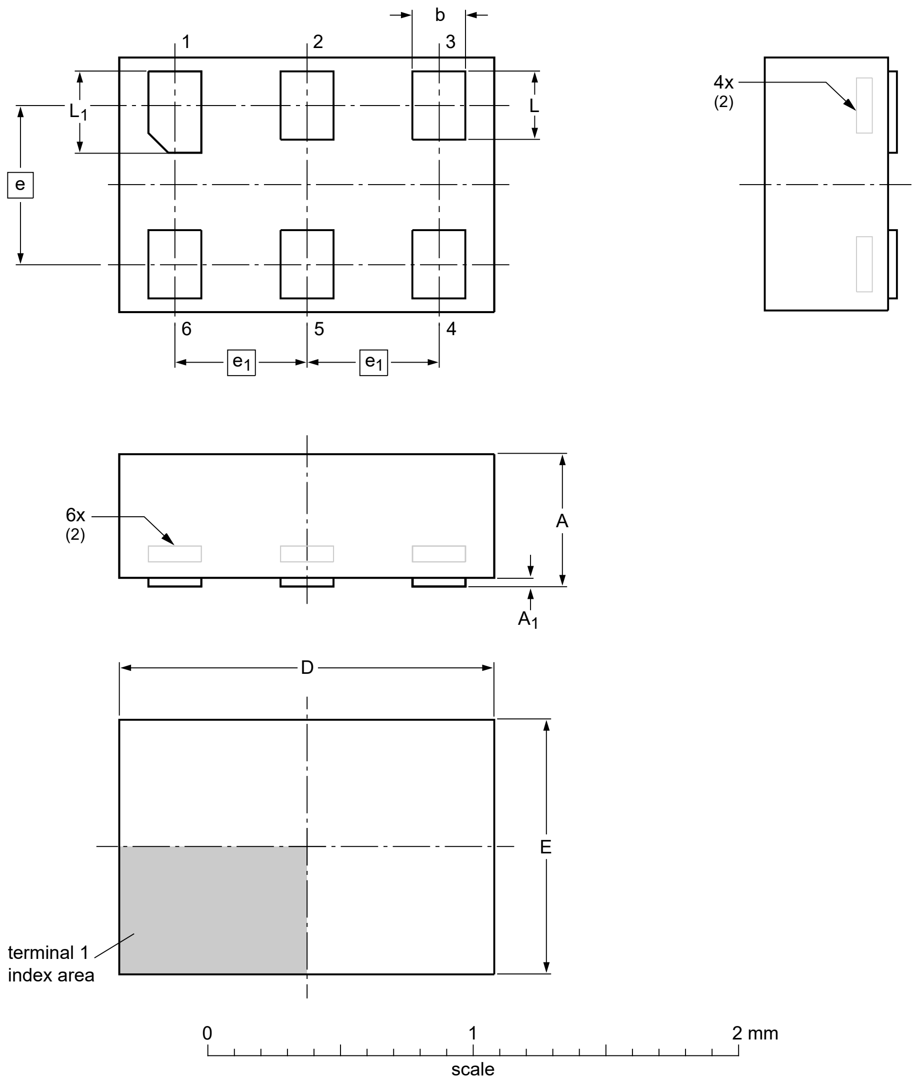
DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1	b_p	c	D	E	e	H_E	L_p	Q	v	w	y
mm	1.1 0.9	0.100 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT753			SC-74A			~~02-04-16~~ 06-03-16

Fig. 13. Package outline SOT753 (SC-74A)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm — SOT886



Dimensions (mm are the original dimensions)

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.5	0.04	0.25	1.50	1.05			0.35	0.40
	nom			0.20	1.45	1.00	0.6	0.5	0.30	0.35
	min			0.17	1.40	0.95			0.27	0.32

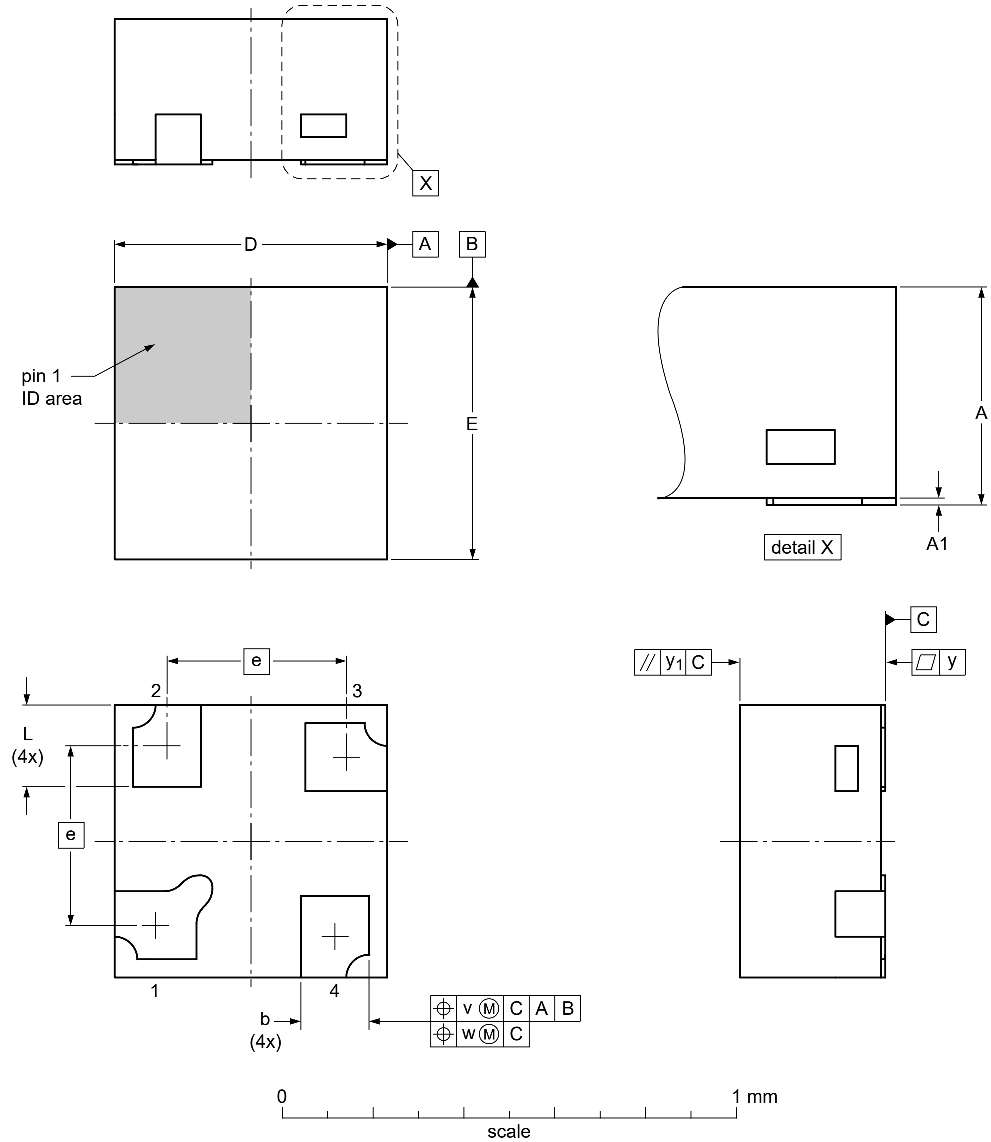
Notes
1. Including plating thickness.
2. Can be visible in some manufacturing processes.

sot886_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT886		MO-252				~~04-07-22~~ 12-01-05

Fig. 14. Package outline SOT886 (XSON6)

X2SON4: plastic thermal enhanced extremely thin small outline package; no leads; 4 terminals; body 0.6 x 0.6 x 0.32 mm **SOT1269-2**



Dimensions (mm are the original dimensions)

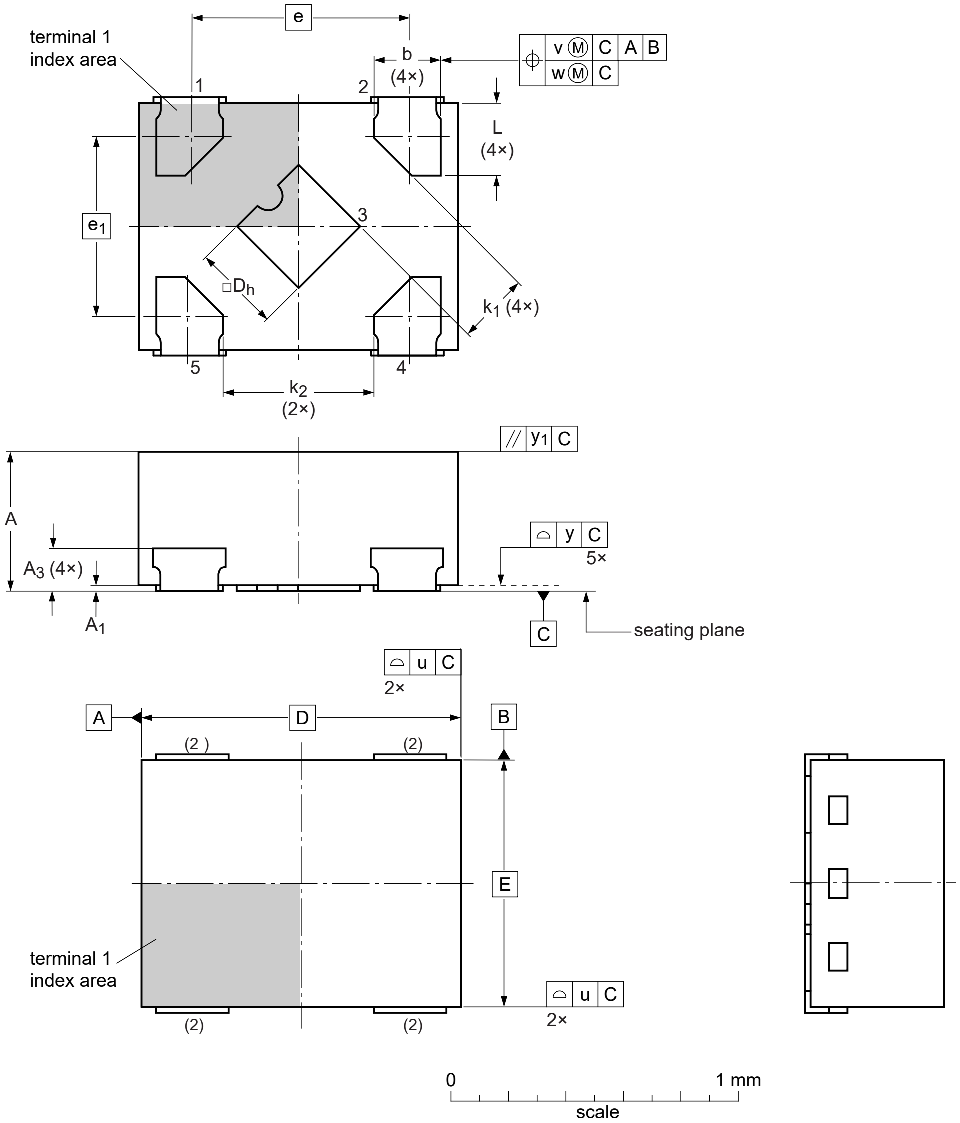
Unit		A	A_1	D	E	b	e	L	v	w	y	y_1
mm	max	0.35	0.04	0.65	0.65	0.20		0.23				
	nom	0.32	0.02	0.60	0.60	0.15	0.40	0.18	0.10	0.05	0.05	0.05
	min	0.30	0.00	0.55	0.55	0.10		0.13				

sot1269-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1269-2		- - -				~~17-04-07~~ 17-06-30

Fig. 15. Package outline SOT1269-2 (X2SON4)

XSON5: Plastic thermal enhanced extremely thin small outline package with side-wettable flanks (SWF); no leads; 5 terminals; body 1.1 × 0.85 × 0.5 mm **SOT8065-1**



Dimensions (mm are the original dimensions)

Unit		$A^{(1)}$	A_1	A_3	b	$D^{(1)}$	D_h	$E^{(1)}$	e	e_1	k_1	k_2	L	u	v	w	y	y_1
mm	max	0.50	0.040		0.28		0.35						0.30					
	nom	0.47	0.020	0.135 (typ)	0.23	1.10	0.30	0.85	0.75	0.6			0.25	0.05	0.1	0.05	0.05	0.05
	min	0.44	0.005		0.20		0.27				0.2	0.45	0.22					

Note:
1. Plastic or metal protrusions per side are not included.
2. Side wettable flanks (SWF), protrusion max. 0.02 mm.

sot8065-1_po

Outline version	References: IEC	References: JEDEC	References: JEITA		European projection	Issue date
SOT8065-1		MO-340				~~24-07-09~~ 24-08-27

Fig. 16. Package outline SOT8065-1 (XSON5)

15. Abbreviations

Table 12. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

16. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G14_Q100 v.9	20241115	Product data sheet	-	74LVC1G14_Q100 v.8
Modifications:	• Type number 74LVC1G14GZ-Q100 (SOT8065-1/XSON5) added.			
74LVC1G14_Q100 v.8	20230815	Product data sheet	-	74LVC1G14_Q100 v.7
Modifications:	• Section 2: ESD specification updated according to the latest JEDEC standard.			
74LVC1G14_Q100 v.7	20220120	Product data sheet	-	74LVC1G14_Q100 v.6
Modifications:	• Fig. 12: Package outline drawing SOT353-1 (TSSOP5) has changed.			
74LVC1G14_Q100 v.6	20210504	Product data sheet	-	74LVC1G14_Q100 v.5
Modifications:	• Section 1 and Section 2 updated.			
74LVC1G14_Q100 v.5	20210127	Product data sheet	-	74LVC1G14_Q100 v.4
Modifications:	• Added type number 74LVC1G14GX4-Q100 (SOT1269-2). • Table 5: Derating values for P_{tot} total power dissipation updated.			
74LVC1G14_Q100 v.4	20190125	Product data sheet	-	74LVC1G14_Q100 v.3
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Added type number 74LVC1G14GM-Q100 (SOT886).			
74LVC1G14_Q100 v.3	20161208	Product data sheet	-	74LVC1G14_Q100 v.2
Modifications:	• Table 7: The maximum limits for leakage current and supply current have changed.			
74LVC1G14_Q100 v.2	20160315	Product data sheet	-	74LVC1G14_Q100 v.1
Modifications:	• Fig. 11 added (typical K-factor for relaxation oscillator).			
74LVC1G14_Q100 v.1	20120709	Product data sheet	-	-

17. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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